



# 1.4MHz, Rail-to-Rail I/O CMOS Operational Amplifier

### **1 FEATURES**

- HIGH GAIN BANDWIDTH:1.4MHz
- RAIL-TO-RAIL INPUT AND OUTPUT ±0.1mV Typical Vos
- INPUT VOLTAGE RANGE: -0.1V to +5.6V with Vs = 5.5V
- SUPPLY RANGE: +2.2V to +5.5V
- SPECIFIED UP TO +125°C
- Micro SIZE PACKAGES: DFN2X2-8

# **2 APPLICATIONS**

- SENSORS
- PHOTODIODE AMPLIFICATION
- ACTIVE FILTERS
- TEST EQUIPMENT
- DRIVING A/D CONVERTERS

### **3 DESCRIPTIONS**

The RS6332 products offer low voltage operation and rail-to-rail input and output, as well as excellent speed/power consumption ratio, providing an excellent bandwidth (1.4MHz) and slew rate of 0.5V/us. The op-amps are unity gain stable and feature an ultra-low input bias current.

The devices are ideal for sensor interfaces, active filters, and portable applications. The RS6332 operational amplifiers are specified at the full temperature range of -40°C to 125°C under single or dual power supplies of 2.2V to 5.5V.

#### **Device Information**<sup>(1)</sup>

PART	PACKAGE	BODY			
NUMBER	FACILAGE	SIZE(NOM)			
RS6332	DFN2X2-8	2.00mm×2.00mm			

(1) For all available packages, see the orderable addendum at the end of the data sheet.



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# **4 REVISION HISTORY**

Note: Page numbers for previous revisions may different from page numbers in the current version.

Version	Change Date	Change Item
A.1	2024/12/12	Initial version completed



# **5 PACKAGE/ORDERING INFORMATION**<sup>(1)</sup>

Orderable Device	Package Type	Pin	Channel	Op Temp(°C) Device Marking <sup>(2</sup>		MSL <sup>(3)</sup>	Package Qty
RS6332XTDE8	DFN2X2-8	8	2	-40°C ~125°C	6332	MSL3	Tape and Reel,3000

NOTE:

(1) This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the right-hand navigation.

(2) There may be additional marking, which relates to the lot trace code information (data code and vendor code), the logo or the environmental category on the device.

(3) RUNIC classify the MSL level with using the common preconditioning setting in our assembly factory conforming to the JEDEC industrial standard J-STD-20F. Please align with RUNIC if your end application is quite critical to the preconditioning setting or if you have special requirement.



# 6 PIN CONFIGURATION AND FUNCTIONS (TOP VIEW)



### **Pin Description**

	PIN		
NAME	RS6332	I/O <sup>(1)</sup>	DESCRIPTION
	DFN2X2-8		
-INA	2	I	Inverting input, channel A
+INA	3	I	Noninverting input, channel A
-INB	6	I	Inverting input, channel B
+INB	5	I	Noninverting input, channel B
OUTA	1	0	Output, channel A
OUTB	7	0	Output, channel B
V-	4	-	Negative (lowest) power supply
V+	8	-	Positive (highest) power supply
-	Thermal Pad	-	Connect thermal pad to V-

(1) I = Input, O = Output.



# **7 SPECIFICATIONS**

#### 7.1 Absolute Maximum Ratings

Over operating free-air temperature range (unless otherwise noted) <sup>(1)</sup>

			MIN	MAX	UNIT	
	Supply, V <sub>S</sub> =(V+) - (V-)			7		
Voltage	Signal input pin <sup>(2)</sup>		(V-)-0.5	(V+) +0.5	V	
	Signal output pin <sup>(3)</sup>		(V-)-0.5	(V+) +0.5		
	Signal input pin <sup>(2)</sup>		-10	10	mA	
Current Signal output pin <sup>(3)</sup>			-150	150	mA	
	Output short-circuits (4)	Cont	Continuous			
ALθ	Package thermal impedance <sup>(5)</sup>	DFN2X2-8		80	°C/W	
	Operating range, T <sub>A</sub>		-40	125		
Temperature	Junction, T <sup>J (6)</sup>		-40	150	°C	
	Storage, T <sub>stg</sub>		-65	150		

(1) Stresses above these ratings may cause permanent damage. Exposure to absolute maximum conditions for extended periods may degrade device reliability. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those specified is not implied.

(2) Input terminals are diode-clamped to the power-supply rails. Input signals that can swing more than 0.5V beyond the supply rails should be current-limited to 10mA or less.

- (3) Output terminals are diode-clamped to the power-supply rails. Output signals that can swing more than 0.5V beyond the supply rails should be current-limited to ±150mA or less.
- (4) Short-circuit to ground, one amplifier per package.
- (5) The package thermal impedance is calculated in accordance with JESD-51.
- (6) The maximum power dissipation is a function of  $T_{J(MAX)}$ ,  $R_{\theta JA}$ , and  $T_A$ . The maximum allowable power dissipation at any ambient temperature is  $P_D = (T_{J(MAX)} T_A) / R_{\theta JA}$ . All numbers apply for packages soldered directly onto a PCB.

#### 7.2 ESD Ratings

The following ESD information is provided for handling of ESD-sensitive devices in an ESD protected area only.

			VALUE	UNIT
		Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 $^{(1)}$	±5000	
V(ESD)	Electrostatic discharge	Charged-device model (CDM), per ANSI/ESDA/JEDEC JS-002 <sup>(2)</sup>	±1000	V
		Machine Model (MM)	±400	

(1) JEDEC document JEP155 states that 500 V HBM allows safe manufacturing with a standard ESD control process.

(2) JEDEC document JEP157 states that 250 V CDM allows safe manufacturing with a standard ESD control process.



### ESD SENSITIVITY CAUTION

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

### 7.3 Recommended Operating Conditions

Over operating free-air temperature range (unless otherwise noted)

		MIN	NOM	MAX	UNIT
Supply voltage, $V_s = (V+) - (V-)$	Single-supply	2.2		5.5	V
	Dual-supply	±1.1		±2.75	v



# 7.4 Electrical Characteristics

(At  $T_A = +25^{\circ}$ C,  $V_S=2.2V$  to 5.5V,  $R_L = 10k\Omega$  connected to  $V_S/2$ , and  $V_{OUT} = V_S/2$ ,  $V_{CM} = V_S/2$ , Full <sup>(9)</sup> = -40°C to +125°C, unless otherwise noted.)<sup>(1)</sup>

			-	RS6332				
	PARAMETER	CONDITIONS	T,	MIN <sup>(2)</sup>	<b>TYP</b> <sup>(3)</sup>	MAX <sup>(2)</sup>	UNIT	
POWER	SUPPLY							
Vs	Operating Voltage Range		25°C	2.2		5.5	V	
lq	Quiescent Current Per Amplifier	Vs=±2.5V, Io=0mA	25°C		62.5	100	uA	
PSRR	Dower Sumply Dejection Datie	$\lambda = 2.2 \lambda = 5.5 \lambda$	25°C	75	92		٩Ŀ	
PSRR	Power-Supply Rejection Ratio	V <sub>s</sub> =2.2V to 5.5V	Full	65			dB	
INPUT								
Vos	Input Offset Voltage	V <sub>CM</sub> = V <sub>S</sub> /2	25°C	-3	±0.1	3	mV	
Vos Tc	Input Offset Voltage Average Drift	V <sub>CM</sub> = V <sub>S</sub> /2	Full		±1		uV/°C	
IB	Input Bias Current <sup>(4)(5)</sup>	V <sub>CM</sub> =0V	25°C		±1	±10	pА	
los	Input Offset Current <sup>(5)</sup>	V <sub>CM</sub> =0V	25°C		±1	±10	pА	
Vсм	Common-Mode Voltage Range	Vs= 5.5V	25°C	-0.1		5.6	V	
	CMRR Common-Mode Rejection Ratio	Vs= 5.5V	25°C	74	93		dB	
CMDD		V <sub>CM</sub> =-0.1V to 3.5V	Full	63				
CIVILIA		V <sub>S</sub> = 5.5V	25°C	60	77		uВ	
		$V_{CM}$ =-0.1V to 5.6V	5.6V Full					
OUTPU	T				-			
Aol	Open-Loop Voltage Gain	R <sub>L</sub> =10KΩ,Vo=(V-)+0.1V	25°C	110	122		dB	
AUL	Open Loop Voltage Gain	to (V+)-0.1V	Full	87			чD	
	Output Swing From Rail	$V_S$ = ±2.5V, R <sub>L</sub> =10K $\Omega$	25°C		10	20	mV	
IOUT	Output Short-Circuit Current <sup>(6)</sup>		25°C	±60	±96		mA	
CLOAD	Capacitive Load Drive				100		pF	
FREQU	ENCY RESPONSE							
SR	Slew Rate <sup>(8)</sup>	G=+1, CL=100pF	25°C		0.5		V/us	
GBP	Gain-Bandwidth Product		25°C		1.4		MHz	
PM	Phase Margin <sup>(5)</sup>		25°C		64		o	
ts	Settling Time,0.1%	V <sub>S</sub> =±2.5V, G=+1, C <sub>L</sub> =100pF, Step=2V	25°C		6.5		us	
tor	Overload Recovery Time	V <sub>IN</sub> •Gain≥V <sub>S</sub> ,G=-10	25°C		5.3		us	
NOISE								
En	Input Voltage Noise	$    f = 0.1Hz \text{ to } 10Hz, \\ V_S = \pm 2.5V $	25°C		4.5		uV <sub>PP</sub>	
en	Input Voltage Noise Density	f = 1KHz	25°C		TBD		nV/√Hz	





NOTE:

- (1) Electrical table values apply only for factory testing conditions at the temperature indicated. Factory testing conditions result in very limited self-heating of the device.
- (2) Limits are 100% production tested at 25°C. Limits over the operating temperature range are ensured through correlations using statistical quality control (SQC) method.
- (3) Typical values represent the most likely parametric norm as determined at the time of characterization. Actual typical values may vary over time and will also depend on the application and configuration.
- (4) Positive current corresponds to current flowing into the device.
- (5) This parameter is ensured by design and/or characterization and is not tested in production.
- (6) The maximum power dissipation is a function of  $T_{J(MAX)}$ ,  $R_{0JA}$ , and  $T_A$ . The maximum allowable power dissipation at any ambient temperature is PD = ( $T_{J(MAX)} T_A$ ) /  $R_{0JA}$ . All numbers apply for packages soldered directly onto a PCB.
- (7) Short circuit test is a momentary test.
- (8) Number specified is the slower of positive and negative slew rates.
- (9) Specified by characterization only.



# 7.5 Typical Characteristics

NOTE: The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only.

At  $T_A = +25^{\circ}$ C,  $V_S=5V$ ,  $R_L = 10k\Omega$  connected to  $V_S/2$ ,  $V_{OUT} = V_S/2$ , unless otherwise noted.







Figure 3. Quiescent Current vs Temperature



Figure 5. Small-Signal Step Response



Figure 2. Power-Supply Rejection Ratio vs Frequency



Figure 4. Input Bias Current vs Temperature



Figure 6. Large-Signal Step Response



# **Typical Characteristics**

NOTE: The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only.

At  $T_A = +25^{\circ}$ C,  $V_S=5V$ ,  $R_L = 10k\Omega$  connected to  $V_S/2$ ,  $V_{OUT} = V_S/2$ , unless otherwise noted.



Figure 7. Negative Overvoltage Recovery



Figure 9. 0.1Hz to 10Hz Input Voltage Noise



Figure 8. Positive Overvoltage Recovery



### **8 APPLICATION AND IMPLEMENTATION**

Information in the following applications sections is not part of the RUNIC component specification, and RUNIC does not warrant its accuracy or completeness. RUNIC's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

### **8.1 Application Notes**

The RS6332 are high precision, rail-to-rail operational amplifiers that can be run from a single-supply voltage 2.2V to 5.5V ( $\pm$ 1.1V to  $\pm$ 2.75V). Supply voltages higher than 7V (absolute maximum) can permanently damage the amplifier. Rail-to-rail input and output swing significantly increases dynamic range, especially in low-supply applications. Good layout practice mandates use of a 0.1uF capacitor place closely across the supply pins.

### 8.2 Layout Guidelins

Attention to good layout practices is always recommended. Keep traces short. When possible, use a PCB ground plane with surface-mount components placed as close to the device pins as possible. Place a 0.1uF capacitor closely across the supply pins. These guidelines should be applied throughout the analog circuit to improve performance and provide benefits such as reducing the EMI susceptibility.



Figure 10. Amplifier with Bypass Capacitors

### 8.3 Instrumentation Amplifier

In the three-op amp, instrumentation amplifier configuration shown in Figure 11.







### 9 PACKAGE OUTLINE DIMENSIONS DFN2X2-8<sup>(2)</sup>



**TOP VIEW** 





RECOMMENDED LAND PATTERN (Unit: mm)

Symbol	Dimensions I	n Millimeters	Dimensions In Inches			
Symbol	Min	Max	Min	Мах		
A <sup>(1)</sup>	0.700	0.800	0.028	0.031		
A1	0.000	0.050	0.000	0.002		
A2	0.203	B(TYP)	0.008(TYP)			
b	0.180	0.300	0.007	0.012		
D <sup>(1)</sup>	1.900	2.100	0.075	0.083		
D1	1.100	1.300	0.043	0.051		
E <sup>(1)</sup>	1.900	2.100	0.075	0.083		
E1	0.600	0.800	0.024	0.031		
e	0.500	)(TYP)	0.020	(TYP)		
L	0.250	0.450	0.010	0.018		

NOTE:

1. Plastic or metal protrusions of 0.075mm maximum per side are not included.

2. This drawing is subject to change without notice.



### 10 TAPE AND REEL INFORMATION REEL DIMENSIONS

TAPE DIMENSION



NOTE: The picture is only for reference. Please make the object as the standard.

### **KEY PARAMETER LIST OF TAPE AND REEL**

Package Type	Reel	Reel	A0	B0	K0	P0	P1	P2	W	Pin1
	Diameter	Width(mm)	(mm)	Quadrant						
DFN2X2-8	7"	9.5	2.30	2.30	1.10	4.0	4.0	2.0	8.0	Q2

NOTE:

1. All dimensions are nominal.

2. Plastic or metal protrusions of 0.15mm maximum per side are not included.



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